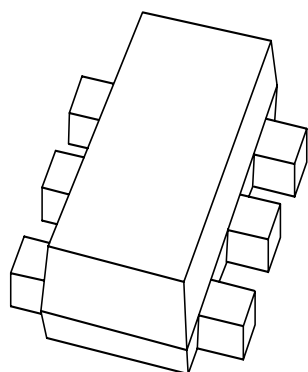


DATA SHEET



BC857BV

PNP general purpose double
transistor

Product specification
Supersedes data of 2001 Sep 10

2001 Nov 07

PNP general purpose double transistor

BC857BV

FEATURES

- 300 mW total power dissipation
- Very small 1.6 mm × 1.2 mm × 0.55 mm ultra thin package
- Excellent coplanarity due to straight leads
- Improved thermal behaviour due to flat leads
- Reduces number of components as replacement of two SC-75/SC-89 packaged BISS transistors
- Reduces required board space
- Reduces pick and place costs.

APPLICATIONS

- General purpose switching and amplification.

DESCRIPTION

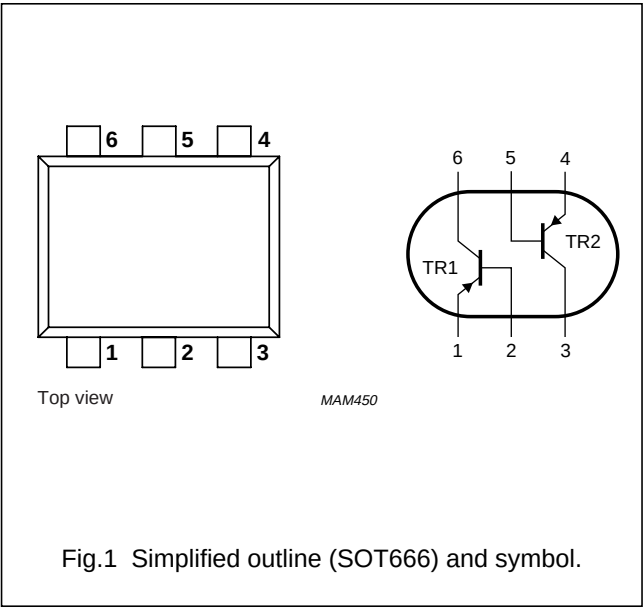
PNP double transistor in a SOT666 plastic package.
NPN complement: BC847BV.

MARKING

TYPE NUMBER	MARKING CODE
BC857BV	3F

PINNING

PIN	DESCRIPTION
1, 4	emitter TR1; TR2
2, 5	base TR1; TR2
6, 3	collector TR1; TR2



PNP general purpose double transistor

BC857BV

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transistor					
V _{CBO}	collector-base voltage	open emitter	–	–50	V
V _{CEO}	collector-emitter voltage	open base	–	–45	V
V _{EBO}	emitter-base voltage	open collector	–	–5	V
I _C	collector current (DC)		–	–100	mA
I _{CM}	peak collector current		–	–200	mA
I _{BM}	peak base current		–	–200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	–	200	mW
T _{stg}	storage temperature		–65	+150	°C
T _j	junction temperature		–	150	°C
T _{amb}	operating ambient temperature		–65	+150	°C
Per device					
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	–	300	mW

Note

1. Transistor mounted on an FR4 printed-circuit board.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	notes 1 and 2	416	K/W

Notes

1. Transistor mounted on an FR4 printed-circuit board.
2. The only recommended soldering method is reflow soldering.

PNP general purpose double transistor

BC857BV

CHARACTERISTICS

$T_{amb} = 25\text{ °C}$; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per transistor						
I_{CBO}	collector-base cut-off current	$I_E = 0; V_{CB} = -30\text{ V}$	–	–	–15	nA
		$I_E = 0; V_{CB} = -30\text{ V}; T_J = 150\text{ °C}$	–	–	–5	μA
I_{EBO}	emitter-base cut-off current	$I_C = 0; V_{EB} = -5\text{ V}$	–	–	–100	nA
h_{FE}	DC current gain	$I_C = -2\text{ mA}; V_{CE} = -5\text{ V}$	200	–	450	
V_{BE}	base-emitter voltage	$I_C = -2\text{ mA}; V_{CE} = -5\text{ V}$	–600	–655	–750	mV
V_{CEsat}	collector-emitter saturation voltage	$I_C = -10\text{ mA}; I_B = -0.5\text{ mA}$	–	–	–100	mV
		$I_C = -100\text{ mA}; I_B = -5\text{ mA}; \text{note 1}$	–	–	–400	mV
V_{BEsat}	base-emitter saturation voltage	$I_C = -10\text{ mA}; I_B = -0.5\text{ mA}$	–	–755	–	mV
C_c	collector capacitance	$I_E = i_e = 0; V_{CB} = -10\text{ V}; f = 1\text{ MHz}$	–	–	2.2	pF
C_e	emitter capacitance	$I_C = i_c = 0; V_{EB} = -500\text{ mV}; f = 1\text{ MHz}$	–	10	–	pF
f_T	transition frequency	$I_C = -10\text{ mA}; V_{CE} = -5\text{ V}; f = 100\text{ MHz}$	100	–	–	MHz

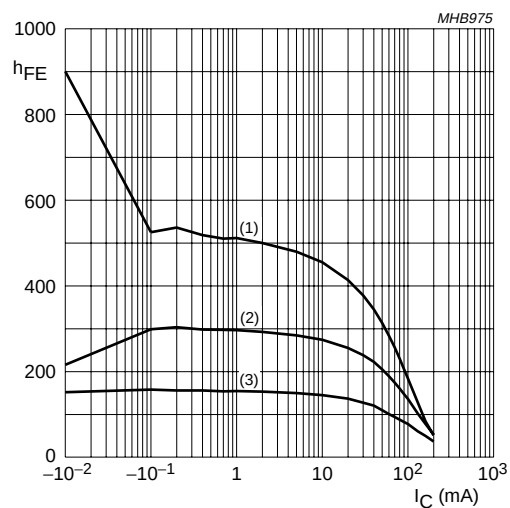
Note

1. Pulse test: $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$.

PNP general purpose double transistor

BC857BV

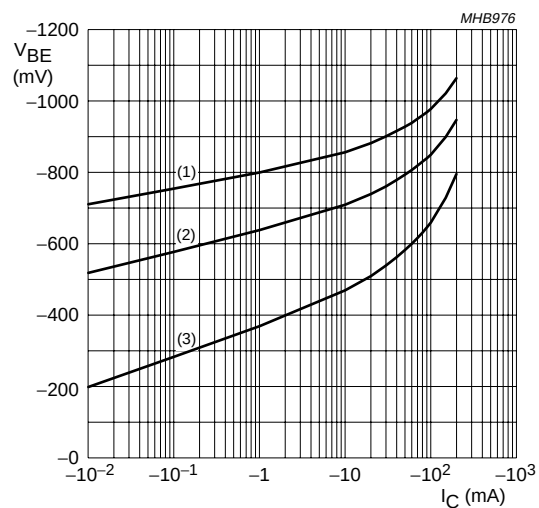
Graphical information BC857BV



$V_{CE} = -5 \text{ V}$.

- (1) $T_{amb} = 150 \text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 25 \text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = -55 \text{ }^{\circ}\text{C}$.

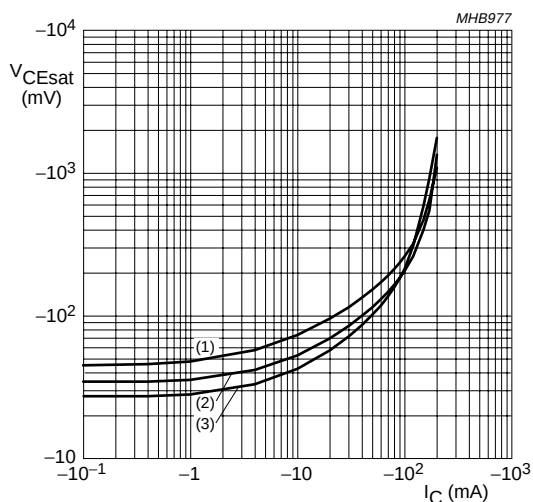
Fig.2 DC current gain; typical values.



$V_{CE} = -5 \text{ V}$.

- (1) $T_{amb} = -55 \text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 25 \text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = 150 \text{ }^{\circ}\text{C}$.

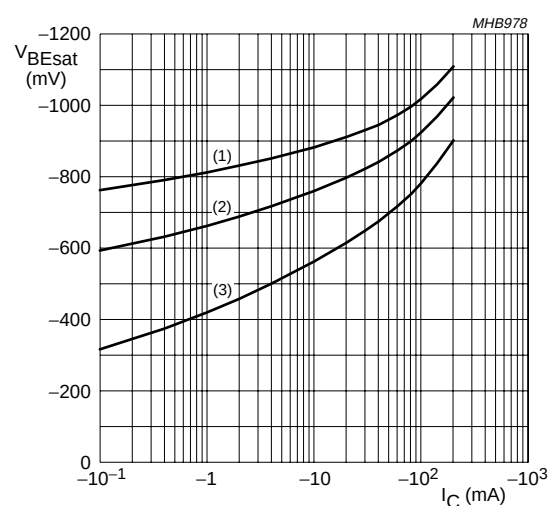
Fig.3 Base-emitter voltage as a function of collector current; typical values.



$I_C/I_B = 20$.

- (1) $T_{amb} = 150 \text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 25 \text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = -55 \text{ }^{\circ}\text{C}$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



$I_C/I_B = 20$.

- (1) $T_{amb} = -55 \text{ }^{\circ}\text{C}$.
- (2) $T_{amb} = 25 \text{ }^{\circ}\text{C}$.
- (3) $T_{amb} = 150 \text{ }^{\circ}\text{C}$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

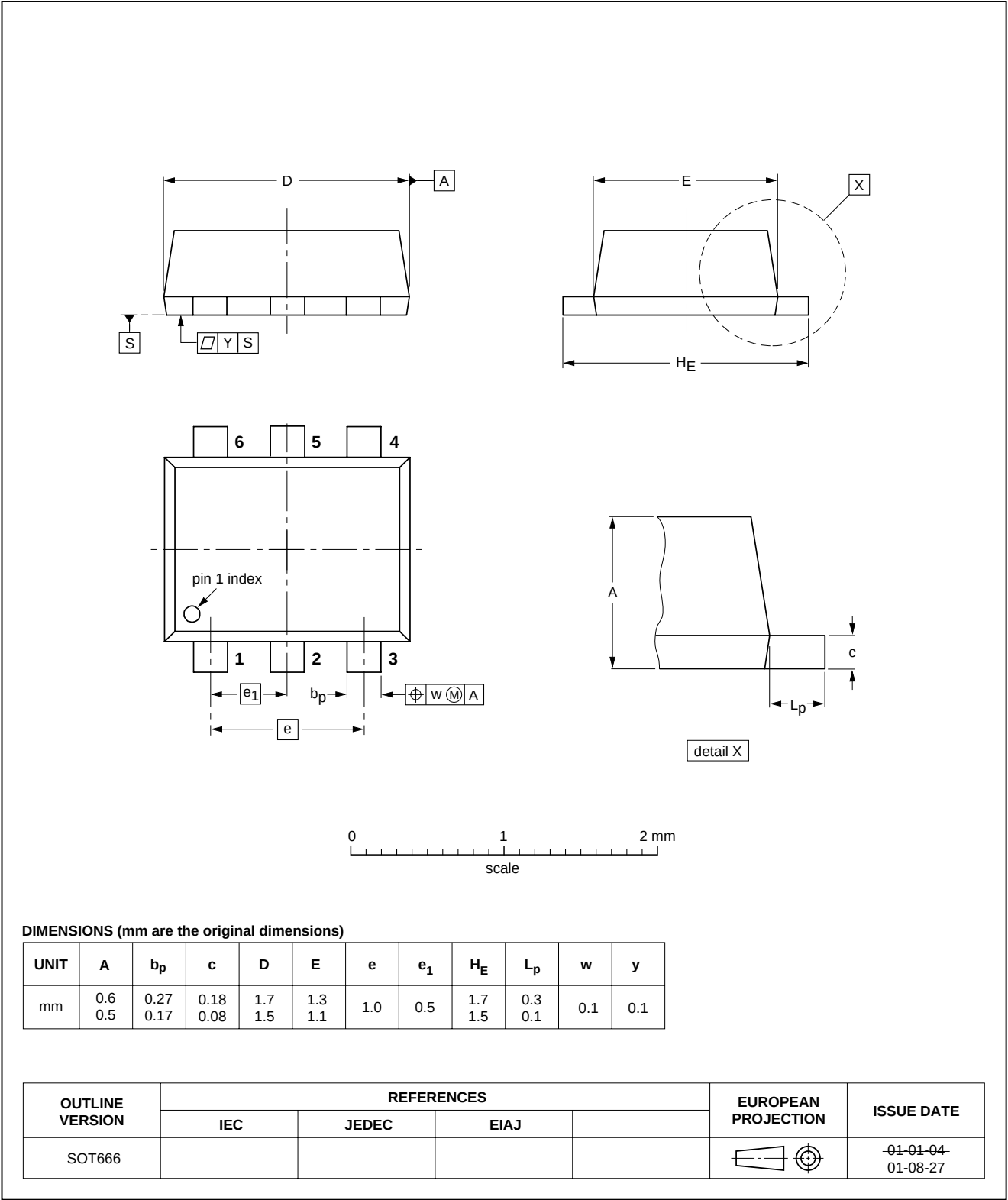
PNP general purpose double transistor

BC857BV

PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT666



PNP general purpose double transistor

BC857BV

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
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